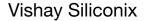
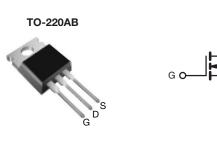
SiHP15N60E





E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.28				
Q _g max. (nC)	76				
Q _{gs} (nC)	11				
Q _{gd} (nC)	17				
Configuration	Single				



S N-Channel MOSFET

FEATURES

- Low Figure-of-Merit (FOM) Ron x Qg
- Low Input Capacitance (C_{iss})
- Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Q_g)
- Avalanche Energy Rated (UIS)
- Material categorization: For definitions please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
 - High-Intensity Discharge (HID)
 - Fluorescent Ballast Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
 - Battery Chargers
 - Renewable Energy
 - Solar (PV Inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP15N60E-E3
Lead (Pb)-free and Halogen-free	SiHP15N60E-GE3

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	600	
Gate-Source Voltage		V _{GS}	± 20	V
Gate-Source Voltage AC (f > 1 Hz)			30	-
	$T_{\rm C} = 25 ^{\circ}{\rm C}$	۱ _D	15	
Continuous Drain Current (T _J = 150 °C)	$V_{GS} \text{ at 10 V} \qquad \begin{array}{c} T_C = 25 \text{ °C} \\ T_C = 100 \text{ °C} \end{array}$		9.6	А
Pulsed Drain Current ^a	I _{DM}	39		
Linear Derating Factor		1.4	W/°C	
Single Pulse Avalanche Energy ^b	E _{AS}	102	mJ	
Maximum Power Dissipation	PD	180	W	
Operating Junction and Storage Temperature Range	TJ, T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope T _J = 125 °C		-I) / (-It	37	2//22
Reverse Diode dV/dt ^d		dV/dt	7.7	V/ns
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^c	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 11.6 mH, $R_g = 25 \Omega$, $I_{AS} = 4.2$ A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D,\, dI/dt$ = 100 A/µs, starting T_J = 25 °C.

S12-0647-Rev. D, 26-Mar-12



Available

www.vishay.com

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		62 0.7		*CAN		
Maximum Junction-to-Case (Drain)	R _{thJC}	-				°C/W		
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	nless otherwi	se noted)						
PARAMETER	SYMBOL	TES		IONS	MIN.	TYP.	MAX.	UNI
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D =	250 µA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D =	250 µA	2	-	4	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20$		-	-	± 100	nA
		V _{DS} =	600 V, V ₀	_{as} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	-		V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		$I_D = 8 A$	-	0.23	0.28	Ω
Forward Transconductance	9 _{fs}	$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 8 \text{ A}$		-	4.6	-	S	
Dynamic							1	
Input Capacitance	C _{iss}		$V_{ab} = 0$	1	-	1350	-	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 100 V,		-	70	-		
Reverse Transfer Capacitance	C _{rss}	-	f = 1 MH	Z	-	5	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	53	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$ V_{DS} = 0$ V	to 480 V,	$V_{GS} = 0 V$	-	177	-	
Total Gate Charge	Qg				-	38	76	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 8	A, V _{DS} = 480 V	-	11	-	nC
Gate-Drain Charge	Q _{gd}				-	17	-	
Turn-On Delay Time	t _{d(on)}				-	17	34	
Rise Time	t _r	V _{DD} :	= 480 V. Ir	. = 8 A.	-	51	77	
Turn-Off Delay Time	t _{d(off)}	$\begin{array}{c c c c c c c c c c c c c c c c c c c $		70	70 ns			
Fall Time	t _f				-	33	66	
Gate Input Resistance	R _g	f = 1	MHz, ope	n drain	-	0.86	-	Ω
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15		
Pulsed Diode Forward Current	I _{SM}			-	-	60	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 8 A	, V _{GS} = 0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}		-		-	410	-	ns
Reverse Recovery Charge	Q _{rr}	T _J = 2	5 °C, I _F =	I _S = 8 A,	_	5.4	-	μΟ
Reverse Recovery Current	I _{RRM}	dl/dt =	100 A/µs,	v _R = 20 V	-	21	-	μ0 A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

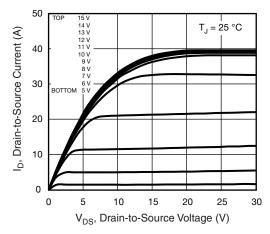


Fig. 1 - Typical Output Characteristics

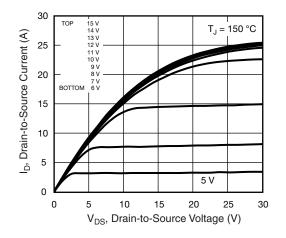


Fig. 2 - Typical Output Characteristics

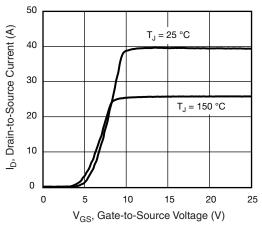


Fig. 3 - Typical Transfer Characteristics

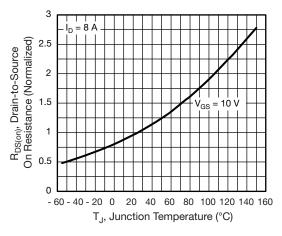


Fig. 4 - Normalized On-Resistance vs. Temperature

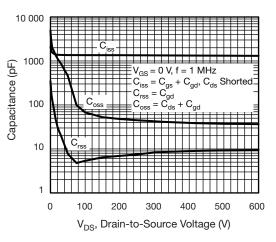


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

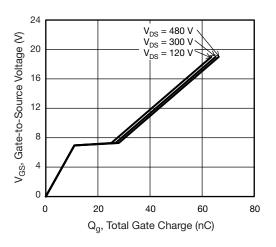


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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SiHP15N60E

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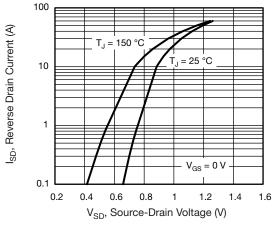


Fig. 7 - Typical Source-Drain Diode Forward Voltage

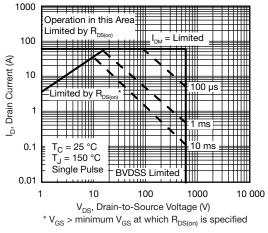


Fig. 8 - Maximum Safe Operating Area

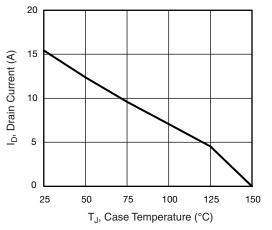


Fig. 9 - Maximum Drain Current vs. Case Temperature

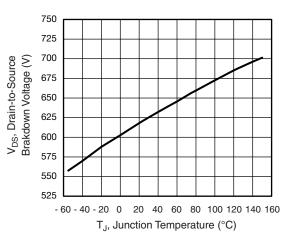
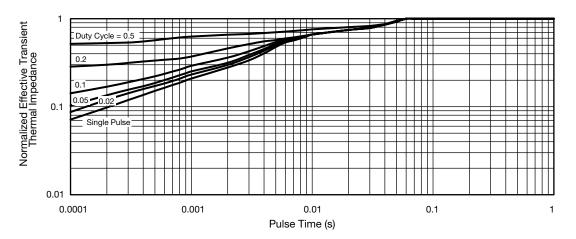
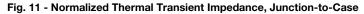


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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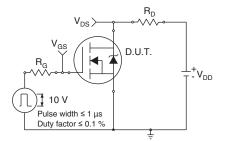


Fig. 12 - Switching Time Test Circuit

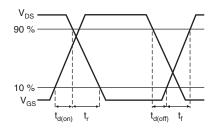


Fig. 13 - Switching Time Waveforms

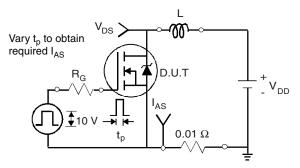


Fig. 14 - Unclamped Inductive Test Circuit

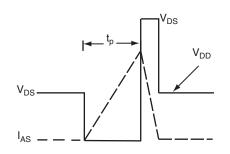


Fig. 15 - Unclamped Inductive Waveforms

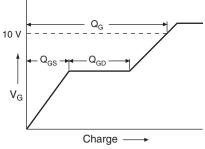


Fig. 16 - Basic Gate Charge Waveform

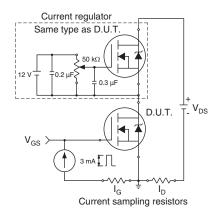
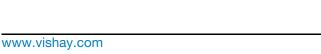


Fig. 17 - Gate Charge Test Circuit

5

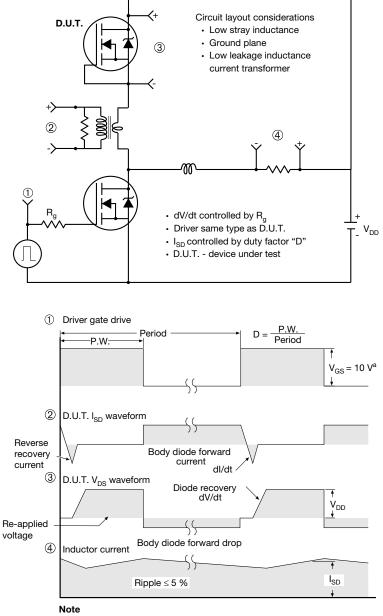
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

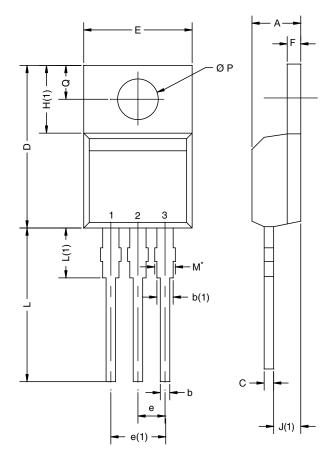
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TO-220AB

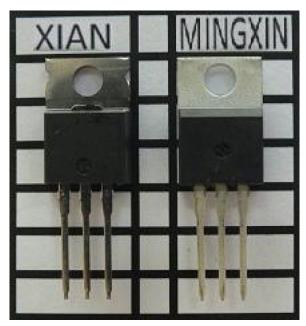


	MILLIN	MILLIMETERS		HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
E	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØΡ	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118

Notes

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM

Xi'an and Mingxin actual photo



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